正基科技股份有限公司

SPECIFICATION

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REVISION：0.2

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正基科技股份有限公司

AMPAK Technology Inc.

AP12276_M2

Data Sheet

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Revision

Revision	Date	Description	Revised By
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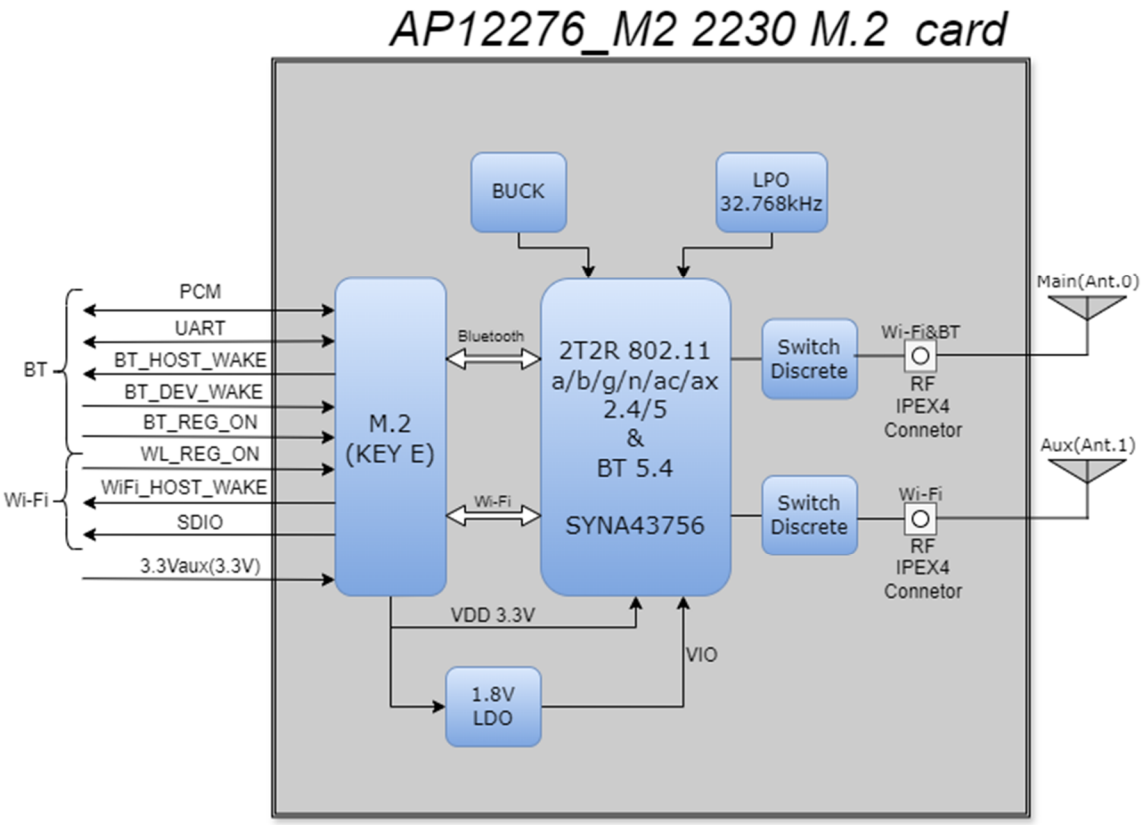
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1. Introduction

1.1 Overview

The AMPAK Technology® AP12276_M2 is a fully Wi-Fi 6E(2.4/5/6 GHz) and Bluetooth functionalities 2230 M.2 card (KEY E) with seamless roaming capabilities and advance security, also it could interact with different vendors' 802.11a/b/g/n/ac/ax 2x2 Access Points with MIMO standard and can accomplish up to speed of 1200Mbps with dual stream in 802.11ax to connect the wireless LAN. Furthermore AP12276_M2 included SDIO interface for Wi-Fi, UART/ PCM interface for Bluetooth

In addition, this compact module is a total solution for a combination of Wi-Fi + BT technologies. The module is specifically developed for tablet, OTT box and portable devices.



1.2 Product Features

IEEE 802.11 Key Feature

- Lead Free design which is compliant with ROHS requirements.
- TX and RX low-density parity check (LDPC) support for improved range and power efficiency.
- Dual-stream spatial multiplexing up to 1200 Mbps data rate.
- 20/40/80 MHz channels for 5GHz and 6GHz (U-NII-5 and U-NII-6) radio, and 20MHz channels for 2.4GHz radio.
- Client MU-MIMO.
- Supports standard SDIO v3.0, compatible with SDIO v2.0 HOST interfaces.

Bluetooth Key Feature

- BT host digital interface:
  - HCI UART (up to 4 Mbps)
  - PCM for audio data
- Complies with Bluetooth Core Specification Version 5.4 with provisions for supporting future specifications. With Bluetooth Class 1 or Class2 transmitter operation.
- Supports extended synchronous connections (eSCO), for enhanced voice quality by allowing for retransmission of dropped packets.
- Adaptive frequency hopping (AFH) for reducing radio frequency interference.

  A simplified block diagram of the module is depicted in the figure above.
- Bluetooth Core Specification Version 5.4, including the following support:
  - Low energy(LE) isochronous channels
  - LE power control
  - LE enhanced connection update
  - LE channel classification
  - LE audio

2. General Specification

2.1 General Specification

Model Name	AP12276_M2
Product Description	2T2R 802.11 a/b/g/n/ac/ax Wi-Fi + BT 5.4 2230 M.2 card (KEY E)
Dimension	L x W : 30 x 22 mm (typical); H : 3.0 mm (max.)
WiFi Interface	SDIO V3.0/ 2.0
BT Interface	UART / PCM
Operating temperature	-30°C to 85°C
Storage temperature	-40°C to 105°C
Humidity	Operating Humidity 10% to 95% Non-Condensing Storage Humidity 5% to 95% Non-Condensing

Note: The optimal RF performance specified in the data sheet, however, is guaranteed only -10 °C to +55 °C and 3.2V < 3.3Vaux < 3.6V without derating performance.

2.2 DC Characteristics

2.2.1 Absolute Maximum Ratings

Symbol	Description	Min.	Max.	Unit
3.3Vaux	Input supply voltage	-0.5	4.5	V
WL_REG_ON	Used by PMU to power up or power down the internal regulators used by the WLAN section.	-0.5	2.07	V
BT_REG_ON	Used by PMU to power up or power down the internal regulators used by the Bluetooth section.			
Digital Bus	UART / PCM Bus			
WL_HOST_WAKE	WLAN device wake-up HOST			
BT_HOST_WAKE	Bluetooth device wake-up HOST			
BT_DEV_WAKE	HOST wake-up Bluetooth device			

Extreme caution must be exercised to prevent electrostatic discharge (ESD) damage.

Symbol	Condition	ESD Rating	Unit
ESD_HAND_HBM	Human body model contact discharge per JEDEC EID/JESD22-A114	1.5	kV
ESD_HAND_CDM	Charged device model contact discharge per JEDEC EIA/JESD22-C101	250	V

2.2.2 Recommended Operating Rating

Voltage rails	Min.	Typ.	Max.	Unit
3.3Vaux	3.0	3.3	3.6	V
WL_REG_ON	1.62	1.8	1.98	V
BT_REG_ON				
Digital Bus				
WL_HOST_WAKE				
BT_HOST_WAKE				
BT_DEV_WAKE				

3.3Vaux current consumption 1200mA(Peak), when 3.3Vaux = 3.3V

I/O Voltage rails @ 1.8V	Min.	Max.	Unit
VIH	1.17	N/A	V
VIL	N/A	0.72	V

I/O Voltage rails @ 3.3V	Min.	Max.	Unit
VIH	2.31	N/A	V
VIL	N/A	0.99	V

3. Wi-Fi RF Specification

3.1 2.4GHz RF Specification

Conditions : 3.3Vaux=3.3V ; Temp:25°C

Feature	Description
WLAN Standard	IEEE 802.11b/g/n/ax & Wi-Fi compliant
Frequency Range	2.400 GHz ~ 2.4835 GHz (2.4GHz ISM Band)
Number of Channels	2.4GHz：Ch1 ~ Ch13
Modulation	802.11b : DQPSK、DBPSK、CCK 802.11 g/n : OFDM /64-QAM、16-QAM、QPSK、BPSK 802.11ax : OFDM /256-QAM、64-QAM、16-QAM、QPSK、BPSK

Output Power (dBm), tolerance ± 1.5 dB

The transmit EVM quality & spectrum mask are compliant with IEEE 802.11 standard

802.11b	**1Mbps**	**2Mbps**	**5.5Mbps**	**11Mbps**	
	19	19	19	19	
802.11g	**6、9Mbps**	**12、18Mbps**	**24Mbps**	**36Mbps**	**48Mbps**
	18	17.5	17.5	17.5	17
	54Mbps				
	17				
802.11n 20MHz	**MCS0~2**	**MCS3**	**MCS4**	**MCS5**	**MCS6**
	18	17.5	17.5	17	17
	MCS7				
	16				
802.11ax 20MHz	**HE0~2**	**HE3**	**HE4**	**HE5**	**HE6**
	18	**17.5**	**17.5**	**17**	**17**
	HE7	**HE8**	**HE9**		
	16	**15**	**14**		

Note: The specifications of RF output power are subject to change to fulfill the safety regulation and requirements in end-user product.

Sensitivity, tolerance ± 2 dB

CCK modulation PER ≦ 8%、OFDM modulation PER ≦ 10%

802.11b	**Data Rate**	**Spec.(dBm)**		
	1Mbps	-97		
	2Mbps	-92		
	5.5Mbps	-90		
	11Mbps	-88		

802.11g SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	6Mbps	-92	24Mbps	-84
	9Mbps	-91	36Mbps	-81
	12Mbps	-90	48Mbps	-77
	18Mbps	-87	54Mbps	-75
802.11g MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	6Mbps	-94	24Mbps	-86
	9Mbps	-93	36Mbps	-83
	12Mbps	-92	48Mbps	-80
	18Mbps	-89	54Mbps	-77
802.11n_20MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-92	MCS4	-80
	MCS1	-88	MCS5	-78
	MCS2	-86	MCS6	-75
	MCS3	-83	MCS7	-74
802.11n_20MHz MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-92	MCS5	-79
	MCS1	-91	MCS6	-77
	MCS2	-89	MCS7	-75
	MCS3	-86	MCS8	-91
	MCS4	-82	MCS15	-74
802.11ax_20MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	HE0	-91	HE6	-74
	HE1	-87	HE7	-73
	HE2	-85	HE8	-70
	HE3	-82	HE9	-68
	HE4	-79		
	HE5	-76		
Maximum Input Level	802.11b : -10 dBm			
	802.11g/n/ax : -20 dBm			

3.2 5GHz RF Specification

Conditions : 3.3Vaux=3.3V ; Temp:25°C

Feature	Description
WLAN Standard	IEEE 802.11a/n/ac/ax & Wi-Fi compliant
Frequency Range	5.15~5.35GHz、5.47~5.725GHz、5.725~5.85GHz (5GHz UNII Band)
Number of Channels	5.15~5.35GHz：Ch36 ~ Ch64 5.47~5.725GHz：Ch100 ~ Ch140 5.725~5.85GHz：Ch149 ~ Ch165
Modulation	802.11a : OFDM /64-QAM、16-QAM、QPSK、BPSK 802.11n : OFDM /64-QAM、16-QAM、QPSK、BPSK 802.11ac : OFDM /256-QAM、OFDM /64-QAM、16-QAM、QPSK、BPSK 802.11ax : OFDM/ 1024-QAM、 OFDM /256-QAM、OFDM /64-QAM、16-QAM、QPSK、BPSK

Output Power(dBm), tolerance ± 2 dB

The transmit EVM quality & spectrum mask are compliant with IEEE 802.11 standard

802.11a	**Frequency (MHz)**	**6~9Mbps**	**12~18Mbps**	**24Mbps**	**36Mbps**
	5150~5350	15	15	15	15
	5470~5720	15	15	15	15
	5725~5845	15	15	15	15
	Frequency (MHz)	**48Mbps**	**54Mbps**		
	5150~5350	15	15		
	5470~5720	15	15		
	5725~5845	15	15		
802.11n 20MHz	**Frequency (MHz)**	**MCS0~2**	**MCS3**	**MCS4**	**MCS5**
	5150~5350	15	15	15	15
	5470~5720	15	15	15	15
	5725~5845	15	15	15	15
	Frequency (MHz)	**MCS6**	**MCS7**		
	5150~5350	15	14		
	5470~5720	15	14		
	5725~5845	15	14		

802.11n 40MHz	Frequency (MHz)	MCS0~2	MCS3	MCS4	MCS5
	5150~5350	15	15	15	15
	5470~5720	14.5	14.5	14.5	14.5
	5725~5845	14.5	14.5	14.5	14.5
	Frequency (MHz)	MCS6	MCS7		
	5150~5350	14.5	14.5		
	5470~5720	14	14		
	5725~5845	14	14		
802.11ac 20MHz	Frequency (MHz)	MCS0~2	MCS3	MCS4	MCS5
	5150~5350	15	15	15	15
	5470~5720	15	15	15	15
	5725~5845	15	15	15	15
	Frequency (MHz)	MCS6	MCS7	MCS8	
	5150~5350	15	14	11.5	
	5470~5720	15	14	11.5	
	5725~5845	15	14	11.5	
802.11ac 40MHz	Frequency (MHz)	MCS0~2	MCS3	MCS4	MCS5
	5150~5350	15	14.5	14.5	14.5
	5470~5720	14.5	14.5	14.5	14.5
	5725~5845	14.5	14.5	14.5	14.5
	Frequency (MHz)	MCS6	MCS7	MCS8	MCS9
	5150~5350	14.5	14.5	12.5	10
	5470~5720	14	14	12	9
	5725~5845	14	14	12	9
802.11ac 80MHz	Frequency (MHz)	MCS0~2	MCS3	MCS4	MCS5
	5150~5350	15	15	15	15
	5470~5720	15	15	15	15
	5725~5845	15	15	15	15
	Frequency (MHz)	MCS6	MCS7	MCS8	MCS9
	5150~5350	14	14	10	10
	5470~5720	14	14	9	9
	5725~5845	14	14	9	9

802.11ax 20MHz	Frequency (MHz)	HE0~2	HE3	HE4	HE5
	5150~5350	15	15	15	15
	5470~5720	15	15	15	15
	5725~5845	15	15	15	15
	Frequency (MHz)	HE6	HE7	HE8	HE9
	5150~5350	15	14	11.5	11.5
	5470~5720	15	14	11.5	11.5
	5725~5845	15	14	11.5	11.5
	Frequency (MHz)	HE10	HE11		
	5150~5350	9.5	9.5		
	5470~5720	9	9		
	5725~5845	9	9		
802.11ax 40MHz	Frequency (MHz)	HE0~2	HE3	HE4	HE5
	5150~5350	15	15	15	15
	5470~5720	14.5	14.5	14.5	14.5
	5725~5845	14.5	14.5	14.5	14.5
	Frequency (MHz)	HE6	HE7	HE8	HE9
	5150~5350	14.5	14.5	12.5	10
	5470~5720	14	14	12	9
	5725~5845	14	14	12	9
	Frequency (MHz)	HE10	HE11		
	5150~5350	8	8		
	5470~5720	7	7		
	5725~5845	7	7		
802.11ax 80MHz	Frequency (MHz)	HE0~2	HE3	HE4	HE5
	5150~5350	14.5	14.5	14.5	14.5
	5470~5720	14.5	14.5	14.5	14.5
	5725~5845	14.5	14.5	14.5	14.5
	Frequency (MHz)	HE6	HE7	HE8	HE9
	5150~5350	14	14	10	10
	5470~5720	14	14	9	9
	5725~5845	14	14	9	9
	Frequency (MHz)	HE10	HE11		
	5150~5350	8	8		
	5470~5720	8	8		
	5725~5845	8	8		

Note: The specifications of RF output power are subject to change to fulfill the safety regulation and requirements in end-user product.

Sensitivity, tolerance ± 2 dB OFDM modulation PER ≦ 10%				
802.11a SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	6Mbps	-89.5	24Mbps	-82
	9Mbps	-89	36Mbps	-79
	12Mbps	-87	48Mbps	-74
	18Mbps	-85	54Mbps	-72
MIMO802.11a MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	6Mbps	-91	24Mbps	-85
	9Mbps	-90	36Mbps	-82
	12Mbps	-89	48Mbps	-77
	18Mbps	-88	54Mbps	-76
802.11n_20MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-89	MCS4	-78
	MCS1	-87	MCS5	-75
	MCS2	-85	MCS6	-72
	MCS3	-82	MCS7	-71
802.11n_20MHz MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-91	MCS5	-77
	MCS1	-90	MCS6	-75
	MCS2	-88	MCS7	-74
	MCS3	-85	MCS8	-89
	MCS4	-81	MCS15	-70
802.11n_40MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-87	MCS4	-76
	MCS1	-85	MCS5	-71
	MCS2	-82	MCS6	-69
	MCS3	-79	MCS7	-68
802.11n_40MHz MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-87	MCS5	-74
	MCS1	-87	MCS6	-72
	MCS2	-85	MCS7	-71
	MCS3	-82	MCS8	-86
	MCS4	-78	MCS15	-67

802.11ac_20MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-89	MCS5	-74
	MCS1	-87	MCS6	-72
	MCS2	-85	MCS7	-69
	MCS3	-82	MCS8	-67
	MCS4	-78		
802.11ac_20MHz MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0,NSS=1	-91	MCS6,NSS=1	-75
	MCS1,NSS=1	-90	MCS7,NSS=1	-74
	MCS2,NSS=1	-87	MCS8,NSS=1	-71
	MCS3,NSS=1	-84	MCS0,NSS=2	-88
	MCS4,NSS=1	-81	MCS8,NSS=2	-66
	MCS5,NSS=1	-76		
02.11ac_40MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-87	MCS5	-71
	MCS1	-85	MCS6	-69
	MCS2	-82	MCS7	-68
	MCS3	-79	MCS8	-64
	MCS4	-75	MCS9	-63
802.11ac_40MHz MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0,NSS=1	-89	MCS6,NSS=1	-72
	MCS1,NSS=1	-87	MCS7,NSS=1	-71
	MCS2,NSS=1	-85	MCS8,NSS=1	-67
	MCS3,NSS=1	-81	MCS9,NSS=1	-65
	MCS4,NSS=1	-78	MCS0,NSS=2	-86
	MCS5,NSS=1	-76	MCS9,NSS=2	-62
802.11ac_80MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0	-84	MCS5	-67
	MCS1	-81	MCS6	-66
	MCS2	-78	MCS7	-64
	MCS3	-75	MCS8	-61
	MCS4	-72	MCS9	-60

802.11ac_80MHz MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	MCS0,NSS=1	-86	MCS6,NSS=1	-69
	MCS1,NSS=1	-84	MCS7,NSS=1	-67
	MCS2,NSS=1	-81	MCS8,NSS=1	-65
	MCS3,NSS=1	-78	MCS9,NSS=1	-62
	MCS4,NSS=1	-75	MCS0,NSS=2	-83
	MCS5,NSS=1	-70	MCS9,NSS=2	-59
802.11ax_20MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	HE0	-89	HE6	-72
	HE1	-87	HE7	-69
	HE2	-85	HE8	-67
	HE3	-82	HE9	-63
	HE4	-78	HE10	-58
	HE5	-74	HE11	-56
802.11ax_40MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	HE0	-87	HE6	-69
	HE1	-85	HE7	-68
	HE2	-82	HE8	-64
	HE3	-79	HE9	-63
	HE4	-75	HE10	-59
	HE5	71	HE11	-54
802.11ax_80MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	HE0	-84	HE6	-66
	HE1	-81	HE7	-64
	HE2	-78	HE8	-61
	HE3	-75	HE9	-60
	HE4	-72	HE10	-56
	HE5	-67	HE11	-52
Maximum Input Level	802.11a/n/ac/ax : -30 dBm			

3.3 6GHz RF Specification

Conditions : VBAT=3.3V ; VDDIO=1.8V ; Temp:25°C

Feature	Description
WLAN Standard	IEEE 802.11ax
Frequency Range	5.925~6525GHz (6GHz U-NII5 & U-NII6 Band)
Number of Channels	5935~5425MHz：Ch191 ~ Ch283 6425~6525GHz：Ch287 ~ Ch303
Modulation	802.11ax : OFDMA /1024-QAM、256-QAM、64-QAM、16-QAM、QPSK、BPSK

Output Power(dBm) , tolerance ± 2 dB

The transmit EVM quality & spectrum mask are compliant with IEEE 802.11 standard

802.11ax 20MHz	Frequency (MHz)	HE0~2	HE3	HE4	HE5
	5955~5415	13.5	13	13	13
	6435~6515	13.5	13	13	13
802.11ax 20MHz	Frequency (MHz)	HE6	HE7	HE8	HE9
	5955~5415	13	12	10	10
	6435~6515	13	12	10	10
	Frequency (MHz)	HE10	HE11		
	5955~5415	7.5	7.5		
	6435~6515	7.5	7.5		
802.11ax 40MHz	Frequency (MHz)	HE0~2	HE3	HE4	HE5
	5955~5415	14	13.5	12.5	12.5
	6435~6515	14	13.5	12.5	12.5
	Frequency (MHz)	HE6	HE7	HE8	HE9
	5955~5415	12	12	10.5	7.5
	6435~6515	12	12	10.5	7.5
	Frequency (MHz)	HE10	HE11		
	5955~5415	6	6		
	6435~6515	6	6		

802.11ax 80MHz	Frequency (MHz)	HE0~2	HE3	HE4	HE5
	5955~5415	14	13.5	12.5	12.5
	6435~6515	14	13.5	12.5	12.5
	Frequency (MHz)	HE6	HE7	HE8	HE9
	5955~5415	12	12	7.5	7.5
	6435~6515	12	12	7.5	7.5
	Frequency (MHz)	HE10	HE11		
	5955~5415	6	6		
	6435~6515	6	6		

Note: The specifications of RF output power are subject to change to fulfill the safety regulation and requirements in end-user product.

Sensitivity, tolerance ± 2 dB, OFDM modulation PER ≦ 10%

802.11ax_20MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	HE0	-87.5	HE6	-70.5
	HE1	-85.5	HE7	-67.5
	HE2	-83.5	HE8	-65.5
	HE3	-82.5	HE9	-61.5
	HE4	-76.2	HE10	-56.5
	HE5	-72.5	HE11	-54.5
802.11ax_20MHz MIMO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	HE0	-87.5	HE6	-70.5
	HE1	-85.5	HE7	-67.5
	HE2	-83.5	HE8	-65.5
	HE3	-80.5	HE9	-61.5
	HE4	-76.5	HE10	-56.5
	HE5	-72.5	HE11	-53.5
802.11ax_40MHz SISO	Data Rate	Spec.(dBm)	Data Rate	Spec.(dBm)
	HE0	-85.5	HE6	-67.5
	HE1	-83.5	HE7	-66.5
	HE2	-80.5	HE8	-62.5
	HE3	-77.5	HE9	-61.5
	HE4	-73.5	HE10	-67.5
	HE5	-69.5	HE11	-52.5

802.11ax_40MHz MIMO	**Data Rate**	**Spec.(dBm)**	**Data Rate**	**Spec.(dBm)**
	HE0	-84.5	**HE6**	-67.5
	HE1	-83.5	**HE7**	-66.5
	HE2	-80.5	**HE8**	-62.5
	HE3	-77.5	**HE9**	-61.5
	HE4	-73.5	**HE10**	-57.5
	HE5	-69.5	**HE11**	-52.5
802.11ax_80MHz SISO	**Data Rate**	**Spec.(dBm)**	**Data Rate**	**Spec.(dBm)**
	HE0	-82.5	**HE6**	-64.5
	HE1	-79.5	**HE7**	-62.5
	HE2	-76.5	**HE8**	-59.5
	HE3	-73.5	**HE9**	-58.5
	HE4	-70.5	**HE10**	-54.5
	HE5	-65.5	**HE11**	-50.5
802.11ax_80MHz MIMO	**Data Rate**	**Spec.(dBm)**	**Data Rate**	**Spec.(dBm)**
	HE0	-81.5	**HE6**	-64.5
	HE1	-79.5	**HE7**	-62.5
	HE2	-76.5	**HE8**	-59.5
	HE3	-73.5	**HE9**	-58.5
	HE4	-70.5	**HE10**	-54.5
	HE5	-65.5	**HE11**	-49.5
Maximum Input Level	802.11ax : -30dBm			

4. Bluetooth Specification

4.1 Bluetooth Specification

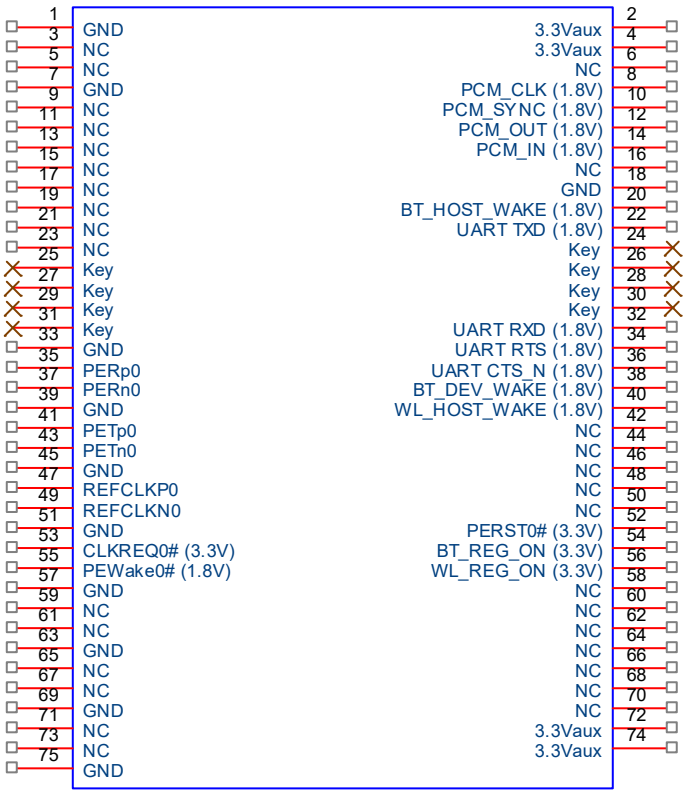
Conditions : 3.3Vaux=3.3V ; Temp:25°C

Feature	**Description**
General Specification	
Bluetooth Standard	BDR(1Mbps) 、EDR(2、3Mbps)、LE(1Mbps)、2LE(2Mbps)
Host Interface	UART
Frequency Band	2402 MHz ~ 2480 MHz
Number of Channels	79 channels for classic、40 channels for BLE
Modulation	FHSS with GFSK, π/4-DQPSK, 8DPSK
RF Specification	
Output Power , tolerance ± 2 dB	
	CL1 (dBm)
BDR Output Power	7
EDR Output Power	6
BLE Output Power	7
Sensitivity, tolerance ± 2 dB	
Sensitivity @ BER=0.1% for GFSK (1Mbps)	-88 dBm
Sensitivity @ BER=0.01% for π/4-DQPSK (2Mbps)	-91 dBm
Sensitivity @ BER=0.01% for 8DPSK (3Mbps)	-85 dBm
Sensitivity @ BER=0.01% for LE (1Mbps)	-91 dBm
Sensitivity @ BER=0.01% for 2LE (2Mbps)	-90 dBm
Maximum Input Level	GFSK (1Mbps):-20dBm
	π/4-DQPSK (2Mbps) :-20dBm
	8DPSK (3Mbps) :-20dBm

Note*：The Bluetooth BDR output power is able to be configured by firmware (hcd file).

5. Pin Definition

5.1 Pin Outline



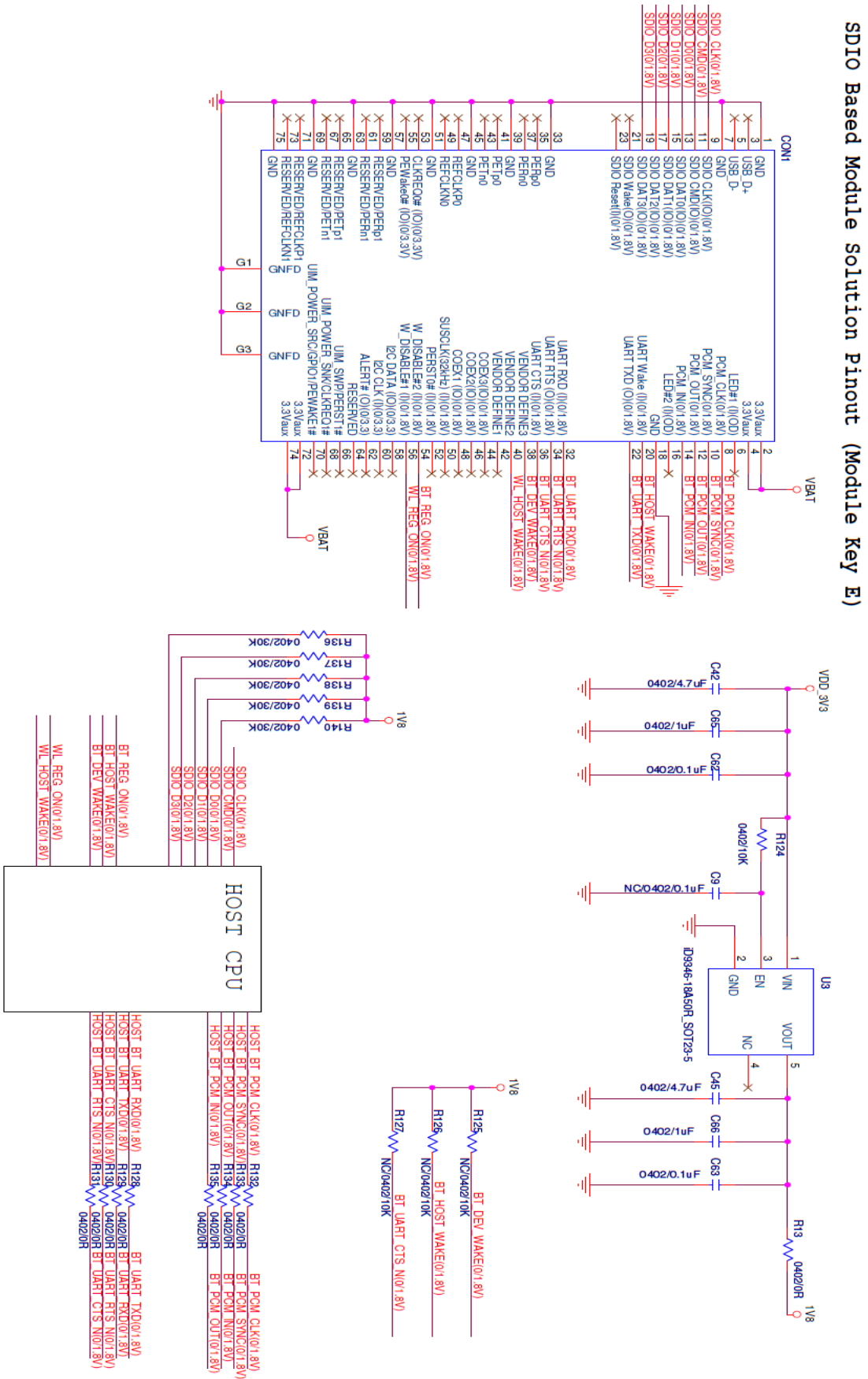
5.2 Pin Assignment

NO	Name	Type	Description
		TOP	
1	GND	G	Ground connections
3	NC	—	No connect
5	NC	—	No connect
7	GND	G	Ground connections
9	SDIO_CLK	I	SDIO clock line
11	SDIO_CMD	I/O	SDIO command line
13	SDIO_DATA_0	I/O	SDIO data line 0
15	SDIO_DATA_1	I/O	SDIO data line 1
17	SDIO_DATA_2	I/O	SDIO data line 2
19	SDIO_DATA_3	I/O	SDIO data line 3
21	NC	—	No connect

23	NC	—	No connect
	Module Key	—	Mechanical Key
	Module Key	—	Mechanical Key
	Module Key	—	Mechanical Key
	Module Key	—	Mechanical Key
33	GND	G	Ground connections
35	NC	—	No connect
37	NC	—	No connect
39	GND	G	Ground connections
41	NC	—	No connect
43	NC	—	No connect
45	GND	G	Ground connections
47	NC	—	No connect
49	NC	—	No connect
51	GND	G	Ground connections
53	NC	—	No connect
55	NC	—	No connect
57	GND	G	Ground connections
59	NC	—	No connect
61	NC	—	No connect
63	GND	G	Ground connections
65	NC	—	No connect
67	NC	—	No connect
69	GND	G	Ground connections
71	NC	—	No connect
73	NC	—	No connect
75	GND	G	Ground connections
	BOTTOM		
2	3.3Vaux	P	VDD system power supply input
4	3.3Vaux	P	VDD system power supply input
6	NC	—	No connect
8	PCM_CLK (1.8V)	I/O	PCM clock
10	PCM_SYNC (1.8V)	I/O	PCM sync signal
12	PCM_OUT (1.8V)	O	PCM Data output
14	PCM_IN (1.8V)	I	PCM data input
16	NC	—	No connect

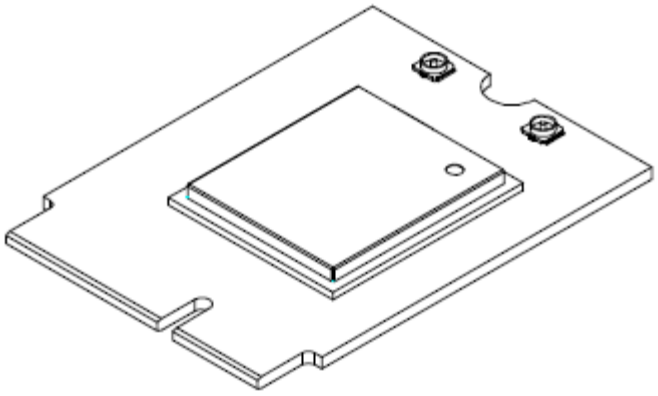
18	GND	G	Ground connections
20	BT_HOST_WAKE (1.8V)	O	Bluetooth wake up Host
22	UART_TXD (1.8V)	O	Bluetooth UART interface
	Module Key	—	Mechanical Key
	Module Key	—	Mechanical Key
	Module Key	—	Mechanical Key
	Module Key	—	Mechanical Key
32	UART_RXD (1.8V)	I	Bluetooth UART interface
34	UART_RTS_N (1.8V)	O	Bluetooth UART interface
36	UART_CTS_N (1.8V)	I	Bluetooth UART interface
38	BT_DEV_WAKE (1.8V)	I	HOST wake-up Bluetooth device
40	WL_HOST_WAKE (1.8V)	O	WLAN wake up HOST
42	NC	—	No connect
44	NC	—	No connect
46	NC	—	No connect
48	NC	—	No connect
50	NC	—	No connect
52	NC	—	No connect
54	BT_REG_ON (1.8V)	I	Used by PMU to power up or power down the internal module regulators used by the Bluetooth section.
56	WL_REG_ON (1.8V)	I	Used by PMU to power up or power down the internal module regulators used by the WLAN section.
58	NC	—	No connect
60	NC	—	No connect
62	NC	—	No connect
64	NC	—	No connect
66	NC	—	No connect
68	NC	—	No connect
70	NC	—	No connect
72	3.3Vaux	P	VDD system power supply input
74	3.3Vaux	P	VDD system power supply input

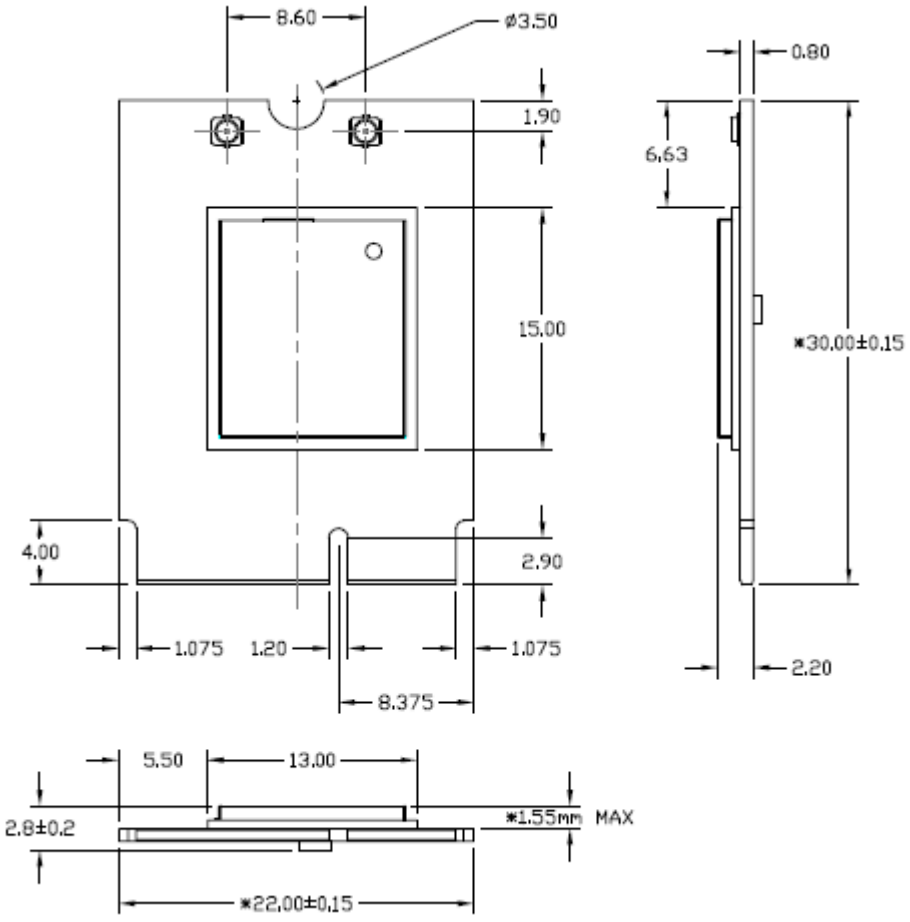
6. Reference Design



7. Dimensions

7.1 Module Dimensions



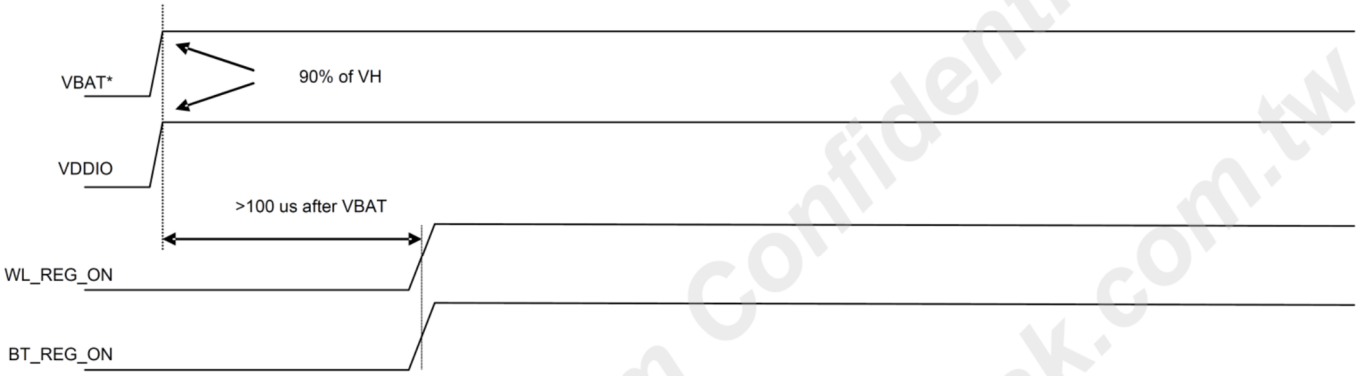


8. Host Interface Timing Diagram

8.1 Power-up Sequence Timing Diagram

The module has signals that allow the host to control power consumption by enabling or disabling the Bluetooth, WLAN and internal regulator blocks. These signals are described below.
Additionally, diagrams are provided to indicate proper sequencing of the signals for carious operating states. The timing value indicated are minimum required values: longer delays are also acceptable.

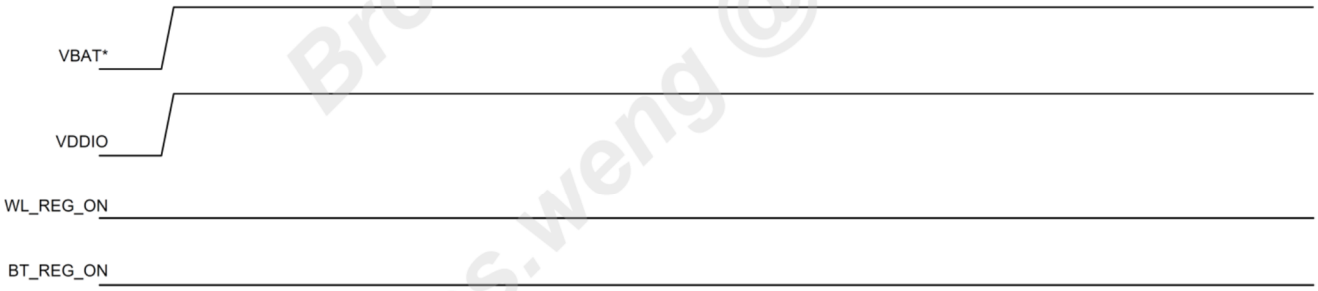
- WL_REG_ON: This signal is used by the PMU to power up the WLAN section. It is also OR-gated with the BT_REG_ON input to control the internal regulators. When this pin is high, the regulators are enabled and the WLAN section is out of reset. When this pin is low, the WLAN section is in reset. If BT_REG_ON and WL_REG_ON are both low, the regulators are disabled. This pin has an internal 33kΩ pull-high resistor.
- BT_REG_ON: This signal is used by the PMU to decide whether or not to power down the internal regulators. If BT_REG_ON and WL_REG_ON are low, the regulators will be disabled. This pin has an internal 33 kΩ pull-high resistor.
- It suggests customers connect WL_REG_ON and BT_REG_ON to GPIOs for control, otherwise unexpected errors may occur when boot-up the device.
- In the figure, VBAT is represented as 3.3Vaux. The VDDIO power supply has been included in the module. When VBAT is power-up, VDDIO will rise to high level after 15 ms.
- The module main chip has an internal power-on reset (POR) circuit. The device will be held in reset for a maximum of 110 ms after VDDC and VDDIO have both passed the POR threshold. Wait at least 150 ms after VDDC and VDDIO are available before initiating PCIe accesses.



*Notes:
1. The VBAT and VDDIO 10%–90% rise-time slopes must be greater than 50 microseconds/V.
2. VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.

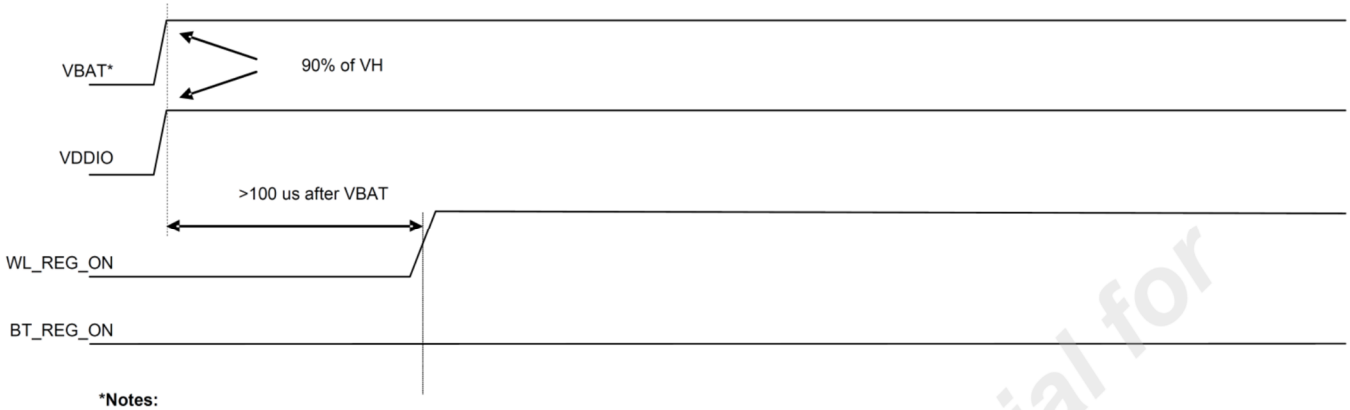
WLAN=ON, Bluetooth=ON

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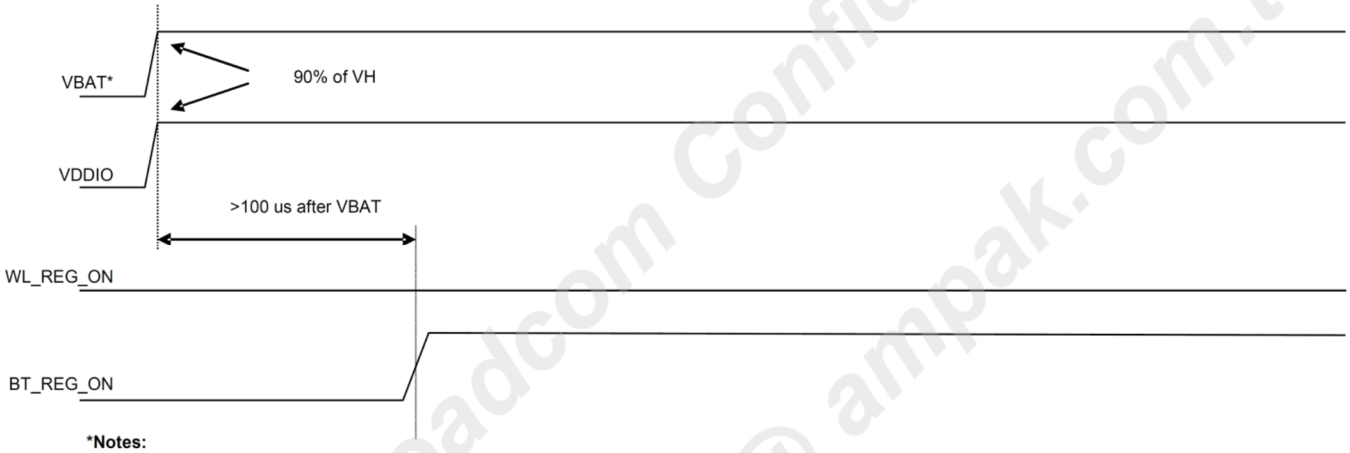
*Notes:
1. The VBAT and VDDIO 10%–90% rise-time slopes must be greater than 50 microseconds/V.
2. VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.

WLAN=OFF, Bluetooth=OFF



*Notes:
1. The VBAT and VDDIO 10%–90% rise-time slopes must be greater than 50 microseconds/V.
2. VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.

WLAN=ON, Bluetooth=OFF



*Notes:
1. The VBAT and VDDIO 10%–90% rise-time slopes must be greater than 50 microseconds/V.
2. VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.

WLAN=OFF, Bluetooth=ON

8.2 SDIO Interface Description

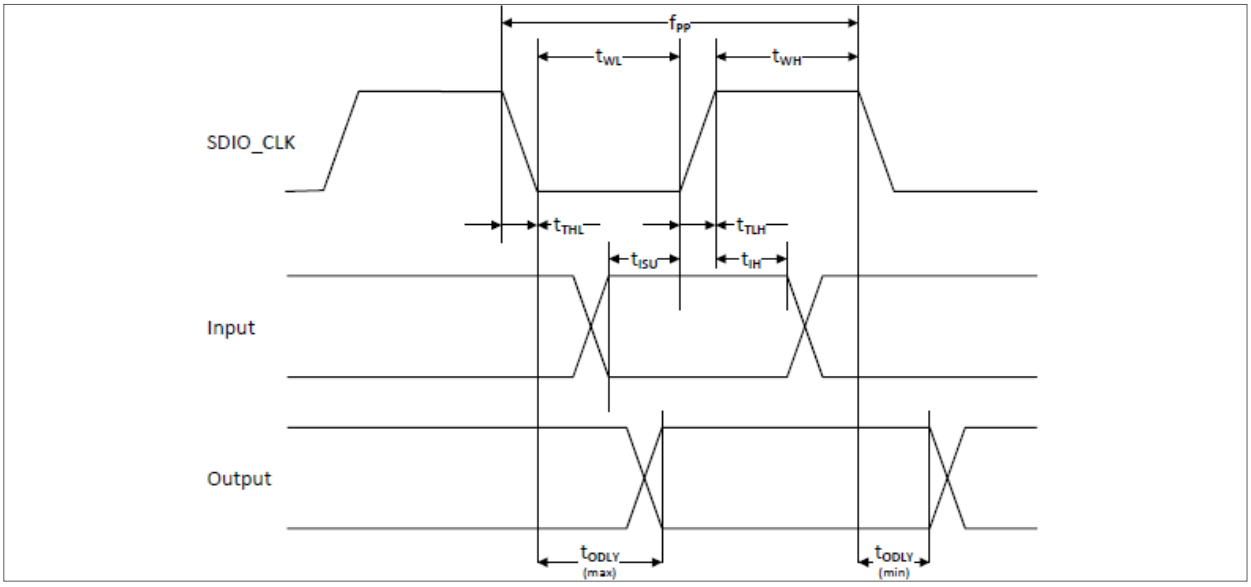
The module supports SDIO version 3.0 for all 1.8V 4-bit UHSI speeds: SDR50(100 Mbps),SDR104(208MHz) and DDR50(50MHz, dual rates). It has the ability to stop the SDIO clock and map the interrupt signal into a GPIO pin. This 'out-of-band' interrupt signal notifies the host when the WLAN device wants to turn on the SDIO interface. The ability to force the control of the gated clocks from within the WLAN chip is also provided.

- Function 0 Standard SDIO function (Max BlockSize / ByteCount = 32B)
- Function 1 Backplane Function to access the internal System On Chip (SOC) address space (Max BlockSize / ByteCount = 64B)
- Function 2 WLAN Function for efficient WLAN packet transfer through DMA (Max BlockSize/ByteCount=512B)

SDIO Pin Description

SD 4-Bit Mode	
DATA0	Data Line 0
DATA1	Data Line 1 or Interrupt
DATA2	Data Line 2 or Read Wait
DATA3	Data Line 3
CLK	Clock
CMD	Command Line

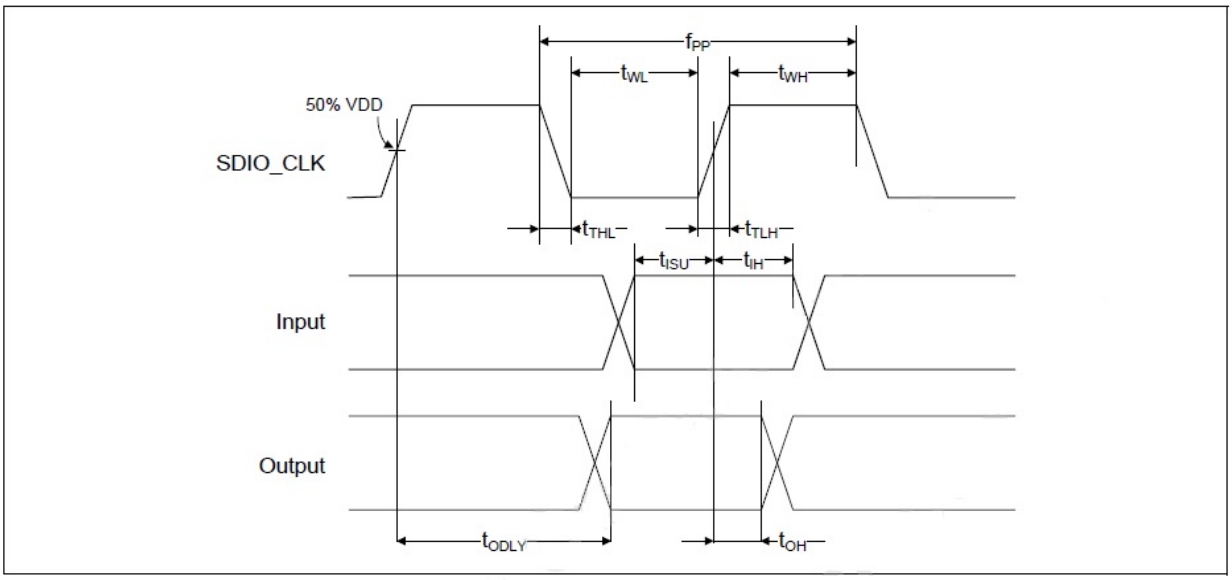
SDIO Default Mode Timing Diagram



Parameter	*Symbol*	*Minimum*	*Typical*	*Maximum*	*Unit*
SDIO CLK (All values are referred to minimum VIH and maximum VIL[b])					
Frequency – Data Transfer mode	fPP	0	–	25	MHz
Frequency – Identification mode	fOD	0	–	400	kHz
Clock low time	tWL	10	–	–	ns
Clock high time	tWH	10	–	–	ns
Clock rise time	tTLH	–	–	10	ns
Clock low time	tTHL	–	–	10	ns
Inputs: CMD, DAT (referenced to CLK)					
Input setup time	tISU	5	–	–	ns
Input hold time	tIH	5	–	–	ns
Outputs: CMD, DAT (referenced to CLK)					
Output delay time – Data Transfer mode	tODLY	0	–	14	ns
Output delay time – Identification mode	tODLY	0	–	50	ns

a. Timing is based on CL ≤ 40pF load on CMD and Data.
b. min(Vih) = 0.7 × VDDIO and max(Vil) = 0.2 × VDDIO.

SDIO High Speed Mode Timing Diagram

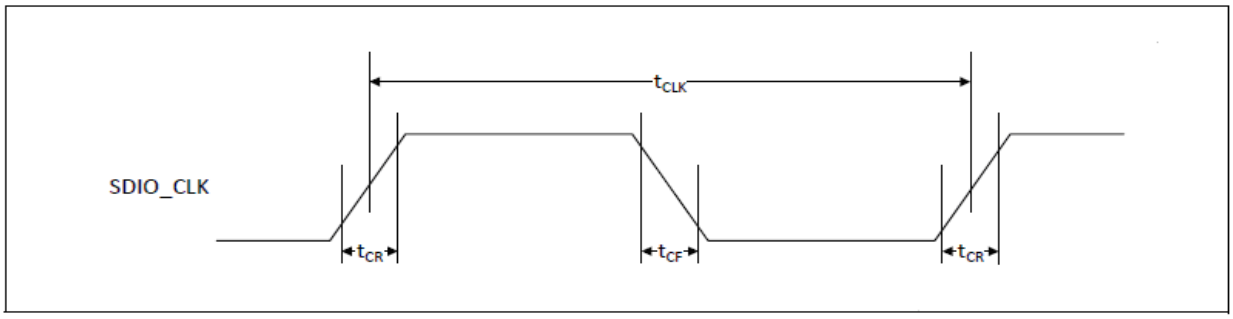


Parameter	*Symbol*	*Minimum*	*Typical*	*Maximum*	*Unit*
SDIO CLK (all values are referred to minimum VIH and maximum VIL[b])					
Frequency – Data Transfer Mode	fPP	0	–	50	MHz
Frequency – Identification Mode	fOD	0	–	400	kHz
Clock low time	tWL	7	–	–	ns
Clock high time	tWH	7	–	–	ns
Clock rise time	tTLH	–	–	3	ns
Clock low time	tTHL	–	–	3	ns
Inputs: CMD, DAT (referenced to CLK)					
Input setup Time	tISU	6	–	–	ns
Input hold Time	tIH	2	–	–	ns
Outputs: CMD, DAT (referenced to CLK)					
Output delay time – Data Transfer Mode	tODLY	–	–	14	ns
Output hold time	tOH	2.5	–	–	ns
Total system capacitance (each line)	CL	–	–	40	pF

a. Timing is based on CL ≤ 40 pF load on CMD and Data.
b. min(Vih) = 0.7 × VDDIO and max(Vil) = 0.2 × VDDIO.

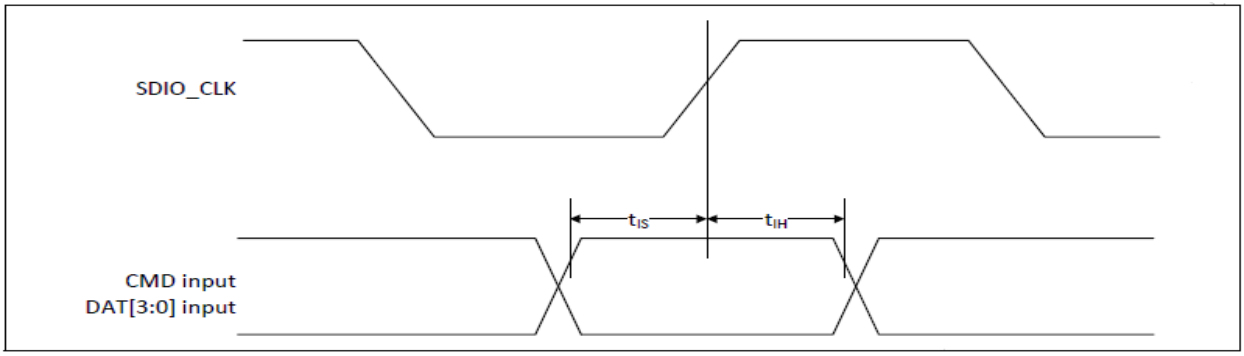
SDIO Bus Timing Specifications in SDR Modes

Clock timing (SDR Modes)



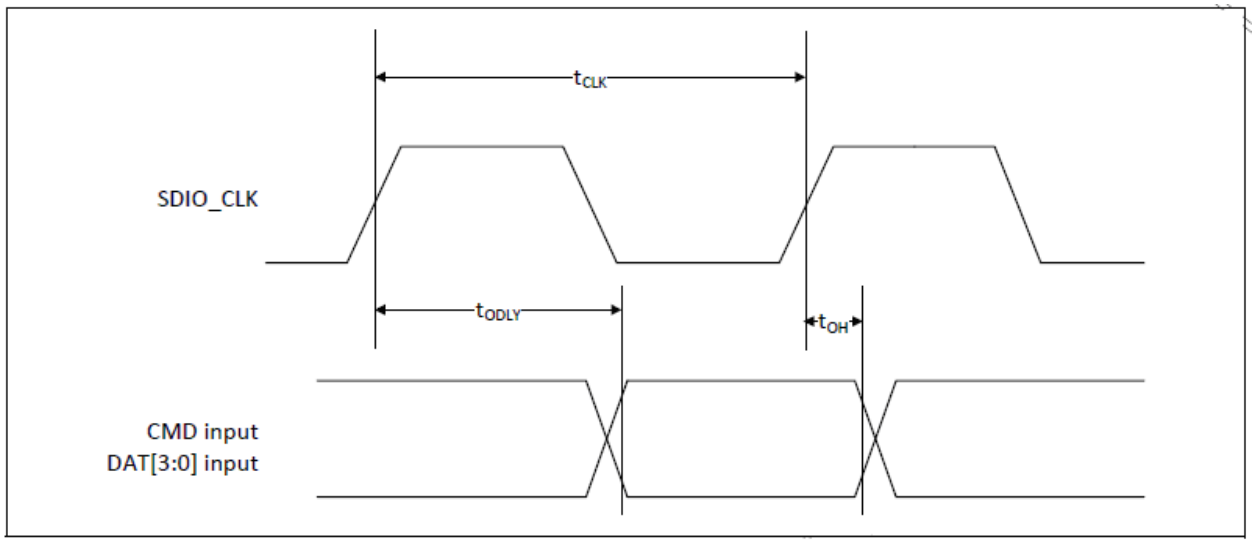
Parameter	Symbol	Minimum	Maximum	Unit	Comments
–	t_{CLK}	40	–	ns	SDR12 mode
		20	–	ns	SDR25 mode
		10	–	ns	SDR50 mode
		4.8	–	ns	SDR104 mode
–	t_{CR}, t_{CF}	–	0.2 × t_{CLK}	ns	t_{CR}, t_{CF} < 2.00 ns (max) @100 MHz, C_{CARD} = 10 pF t_{CR}, t_{CF} < 0.96 ns (max) @208 MHz, C_{CARD} = 10 pF
Clock duty	–	30	70	%	–

SDIO Bus Input timing (SDR Modes)



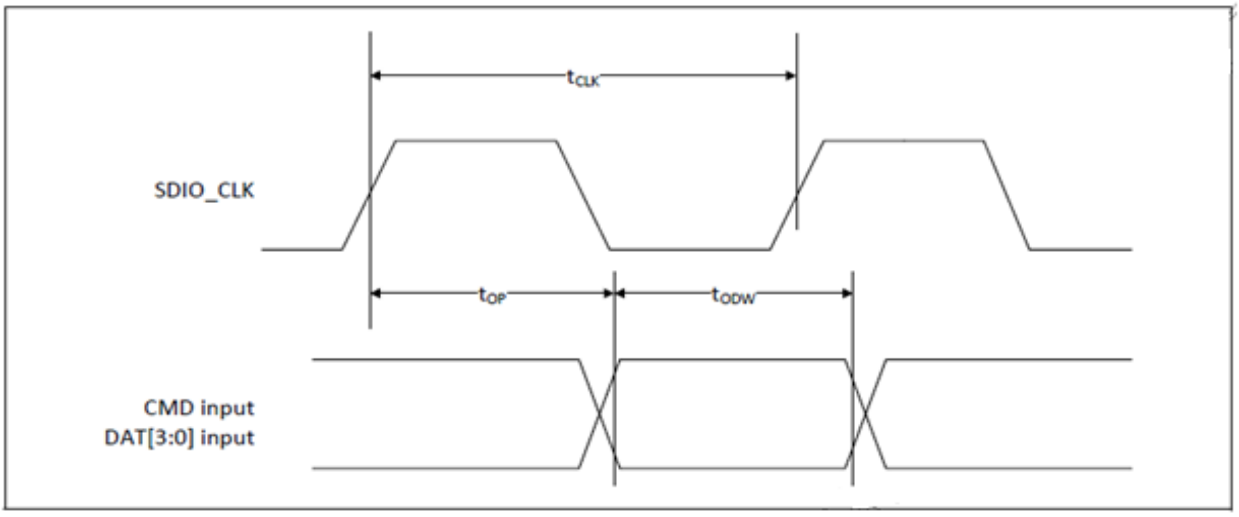
Symbol	Minimum	Maximum	Unit	Comments
SDR104 Mode				
t_{IS}	1.4	–	ns	C_{CARD} = 10 pF, VCT = 0.975V
t_{IH}	0.80	–	ns	C_{CARD} = 5 pF, VCT = 0.975V
SDR50 Mode				
t_{IS}	3.00	–	ns	C_{CARD} = 10 pF, VCT = 0.975V
t_{IH}	0.80	–	ns	C_{CARD} = 5 pF, VCT = 0.975V

SDIO Bus output timing (SDR Modes up to 100MHz)



Symbol	Minimum	Maximum	Unit	Comments
t_{ODLY}	–	7.5	ns	t_{CLK} ≥ 10 ns C_L = 30 pF using driver type B for SDR50
t_{ODLY}	–	14.0	ns	t_{CLK} ≥ 20 ns C_L = 40 pF using for SDR12, SDR25
t_{OH}	1.5	–	ns	Hold time at the t_{ODLY} (min) C_L = 15 pF

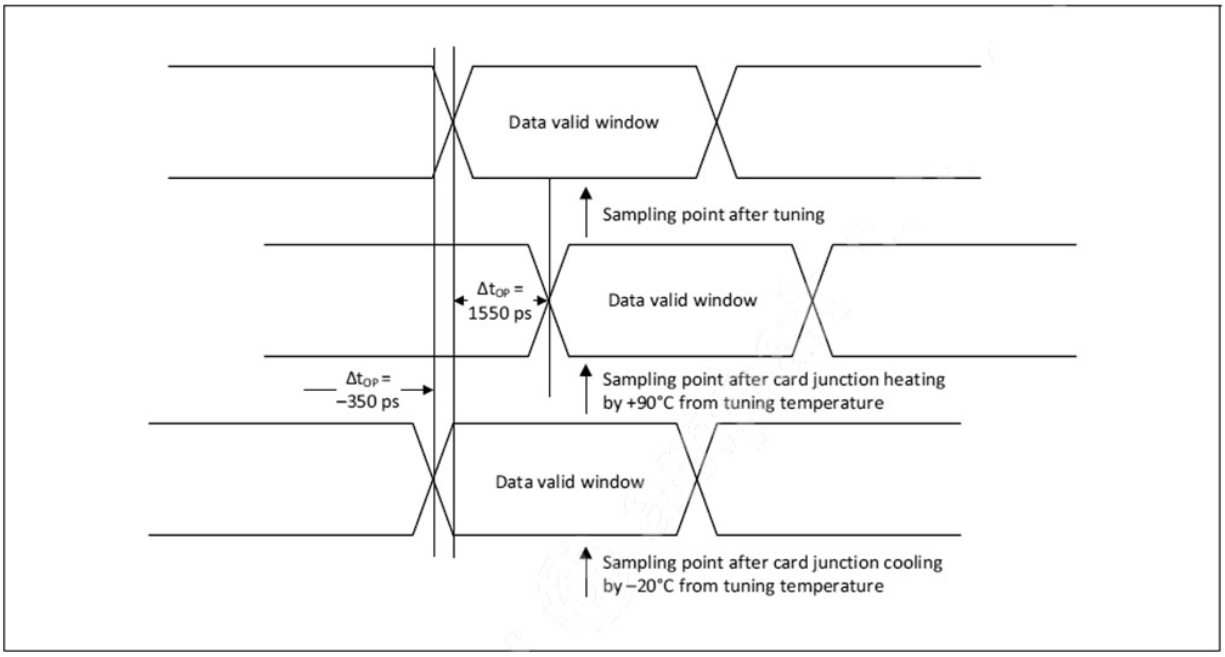
Card output timing (SDR Modes 100MHz to 208MHz)



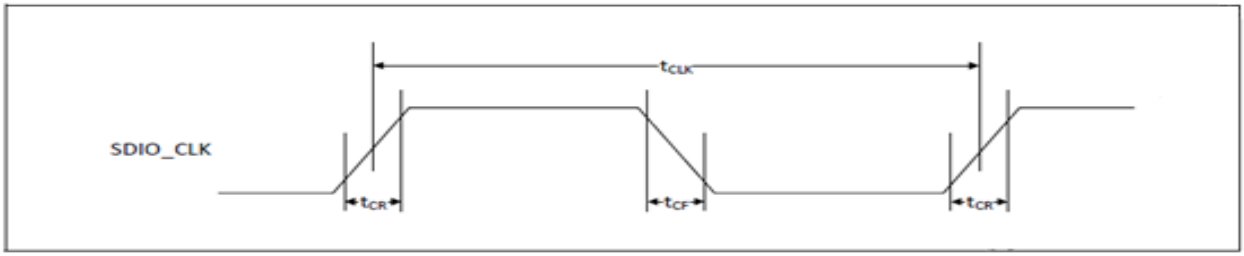
Symbol	Minimum	Maximum	Unit	Comments
t_{OP}	0	2	UI	Card output phase
Δt_{OP}	–350	+1550	ps	Delay variation due to temp change after tuning
t_{ODW}	0.60	–	UI	t_{ODW}=2.88 ns @208 MHz

- Δt_{OP} = +1550 ps for junction temperature of Δt_{OP} = 90 degrees during operation
- Δt_{OP} = –350 ps for junction temperature of Δt_{OP} = –20 degrees during operation
- Δt_{OP} = +2600 ps for junction temperature of Δt_{OP} = –20 to +125 degrees during operation

Δt_{OP} Consideration for Variable Data Window (SDR 104 Mode)

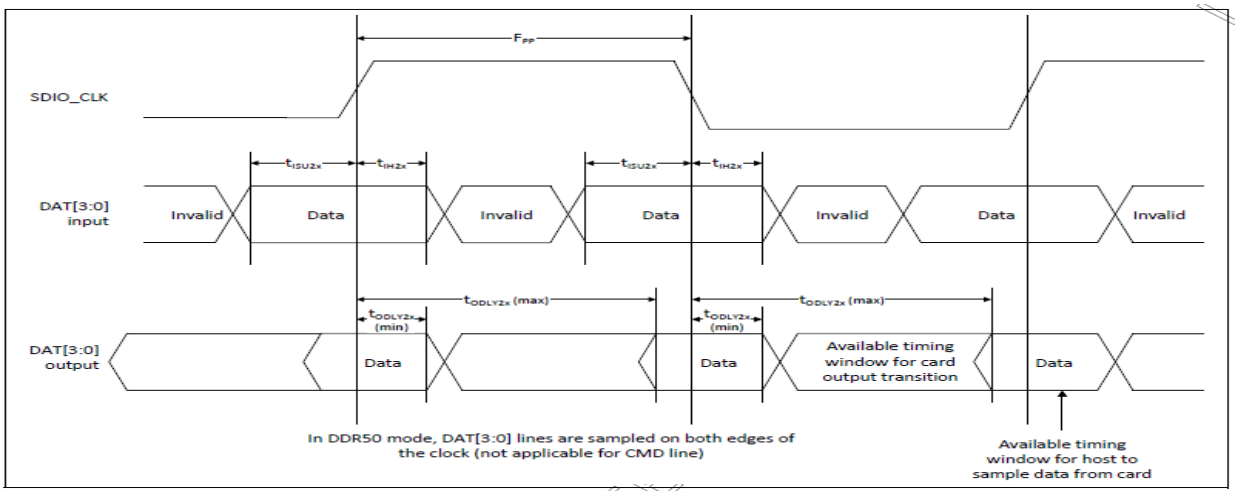


SDIO Bus Timing Specifications in DDR50 Mode



Parameter	Symbol	Minimum	Maximum	Unit	Comments
–	t_{CLK}	20	–	ns	DDR50 mode
–	t_{CR},t_{CF}	–	0.2 × tCLK	ns	t_{CR}, t_{CF} < 4.00 ns (max) @50 MHz, C_{CARD} = 10 pF
Clock duty	–	45	55	%	–

Data Timing



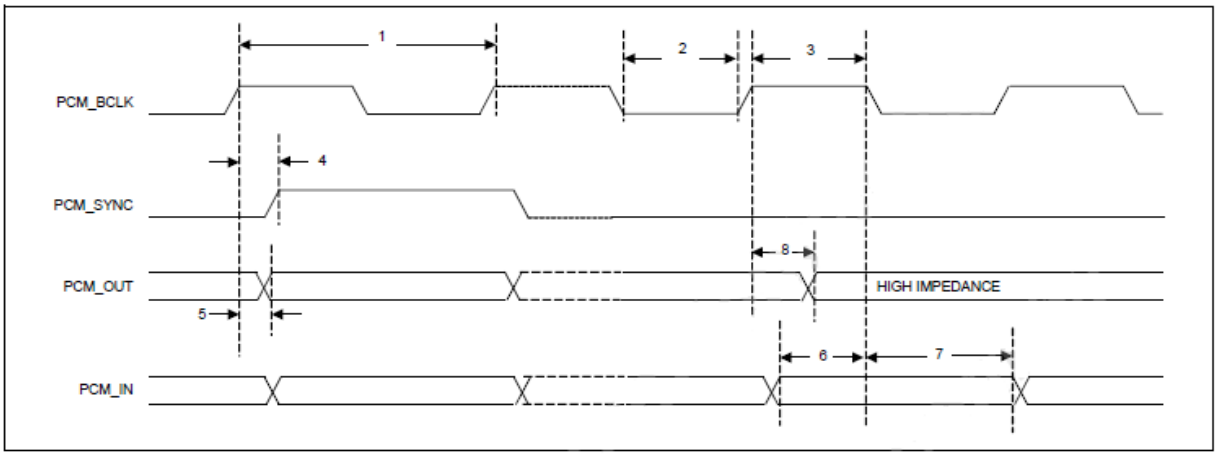
Parameter	Symbol	Minimum	Maximum	Unit	Comments
Input CMD					
Input setup time	t_{ISU}	6	–	ns	C_{CARD} < 10 pF (1 Card)
Input hold time	t_{IH}	0.8	–	ns	C_{CARD} < 10 pF (1 Card)
Output CMD					
Output delay time	t_{ODLY}	–	13.7	ns	C_{CARD} < 30 pF (1 Card)
Output hold time	t_{OH}	1.5	–	ns	C_{CARD} < 15 pF (1 Card)
Input DAT					
Input setup time	t_{ISU2x}	3	–	ns	C_{CARD} < 10 pF (1 Card)
Input hold time	t_{IH2x}	0.8	–	ns	C_{CARD} < 10 pF (1 Card)
Output DAT					
Output delay time	t_{ODLY2x}	–	7.5	ns	C_{CARD} < 25 pF (1 Card)
Output hold time	t_{ODLY2x}	1.5	–	ns	C_{CARD} < 15 pF (1 Card)

8.3 PCM Interface Description

The PCM Interface on the AP6276S can connect to linear PCM Codec devices in master or slave mode. In master mode, the AP6276S generates the PCM_CLK and PCM_SYNC signals, and in slave mode, these signals are provided by another master on the PCM interface and are inputs to the AP6276S.The configuration of the PCM interface may be adjusted by the host through the use of vendor-specific HCI commands.

Short Frame Sync, Master Modem

PCM Timing Diagram (Short Frame Sync, Master Mode)

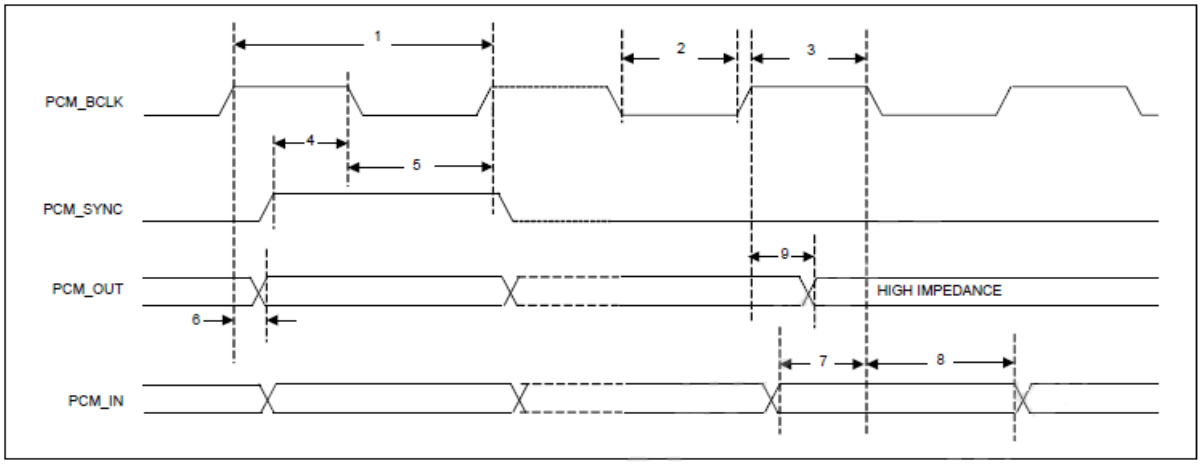


PCM Interface Timing Specifications (Short Frame Sync, Master Mode)

Reference	Characteristics	Minimum	Typical	Maximum	Unit
1	PCM bit clock frequency		–	12	MHz
2	PCM bit clock low	41	–	–	ns
3	PCM bit clock high	41	–	–	ns
4	PCM_SYNC delay	0	–	25	ns
5	PCM_OUT delay	0	–	25	ns
6	PCM_IN setup	8	–	–	ns
7	PCM_IN hold	8	–	–	ns
8	Delay from rising edge of PCM_BCLK during last bit period to PCM_OUT becoming high impedance	0	–	25	ns

Short Frame Sync, Slave Mode

PCM Timing Diagram (Short Frame Sync, Slave Mode)

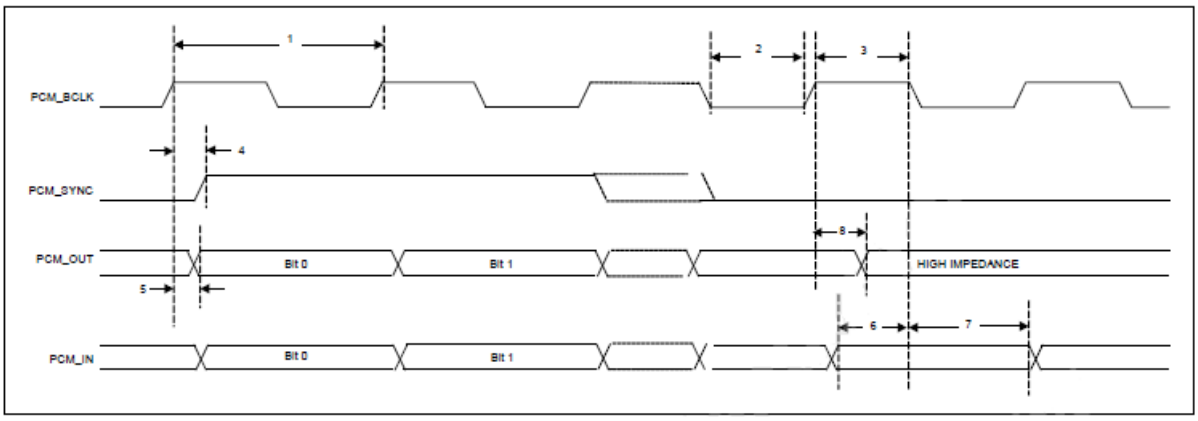


PCM Interface Timing Specifications (Short Frame Sync, Slave Mode)

Reference	Characteristics	Minimum	Typical	Maximum	Unit
1	PCM bit clock frequency	–	–	12	MHz
2	PCM bit clock low	41	–	–	ns
3	PCM bit clock high	41	–	–	ns
4	PCM_SYNC setup	8	–	–	ns
5	PCM_SYNC hold	8	–	–	ns
6	PCM_OUT delay	0	–	25	ns
7	PCM_IN setup	8	–	–	ns
8	PCM_IN hold	8	–	–	ns
9	Delay from rising edge of PCM_BCLK during last bit period to PCM_OUT becoming high impedance	0	–	25	ns

Long Frame Sync, Master Mode

PCM Timing Diagram (Long Frame Sync, Master Mode)

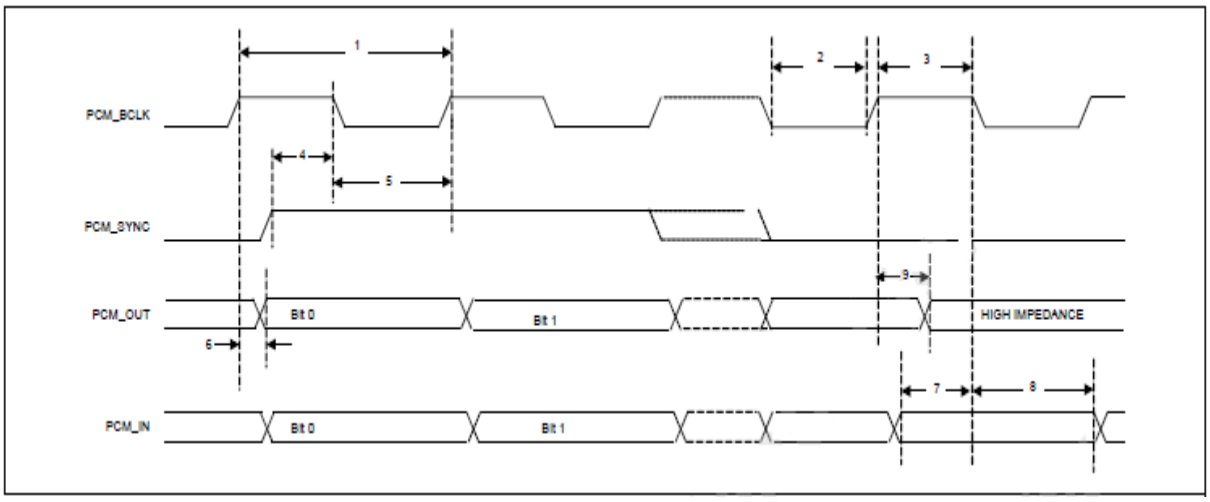


PCM Interface Timing Specifications (Long Frame Sync, Master Mode)

Reference	*Characteristics*	*Minimum*	*Typical*	*Maximum*	*Unit*
1	PCM bit clock frequency	–	–	12	MHz
2	PCM bit clock low	41	–	–	ns
3	PCM bit clock high	41	–	–	ns
4	PCM_SYNC delay	0	–	25	ns
5	PCM_OUT delay	0	–	25	ns
6	PCM_IN setup	8	–	–	ns
7	PCM_IN hold	8	–	–	ns
8	Delay from rising edge of PCM_BCLK during last bit period to PCM_OUT becoming high impedance	0	–	25	ns

Long Frame Sync, Slave Mode

PCM Timing Diagram (Long Frame Sync, Slave Mode)

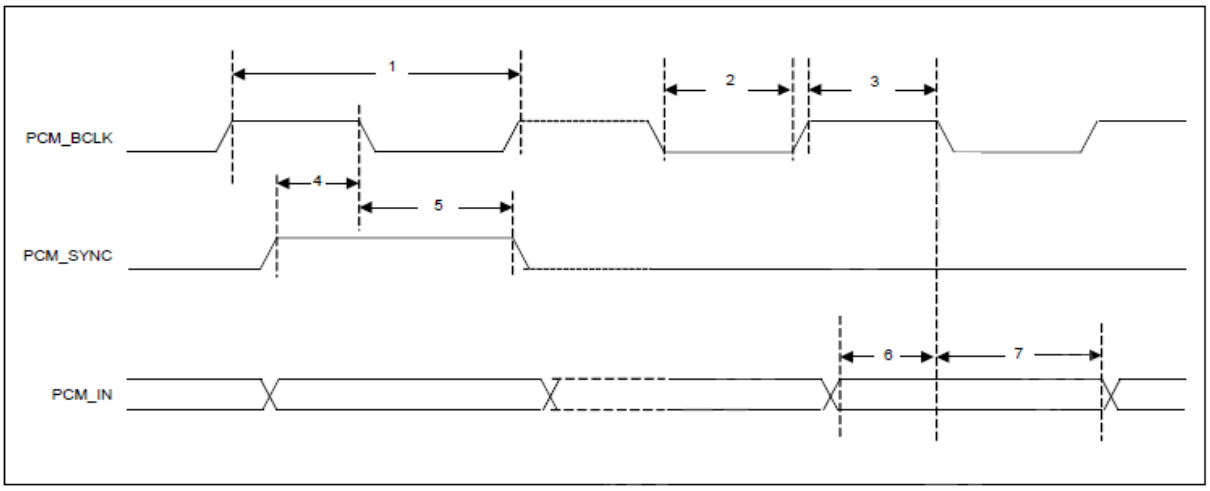


PCM Interface Timing Specifications (Long Frame Sync, Slave Mode)

Reference	Characteristics	Minimum	Typical	Maximum	Unit
1	PCM bit clock frequency	–	–	12	MHz
2	PCM bit clock low	41	–	–	ns
3	PCM bit clock high	41	–	–	ns
4	PCM_SYNC setup	8	–	–	ns
5	PCM_SYNC hold	8	–	–	ns
6	PCM_OUT delay	0	–	25	ns
7	PCM_IN setup	8	–	–	ns
8	PCM_IN hold	8	–	–	ns
9	Delay from rising edge of PCM_BCLK during last bit period to PCM_OUT becoming high impedance	0	–	25	ns

Short Frame Sync, Burst Mode

PCM Burst Mode Timing (Receive Only, Short Frame Sync)

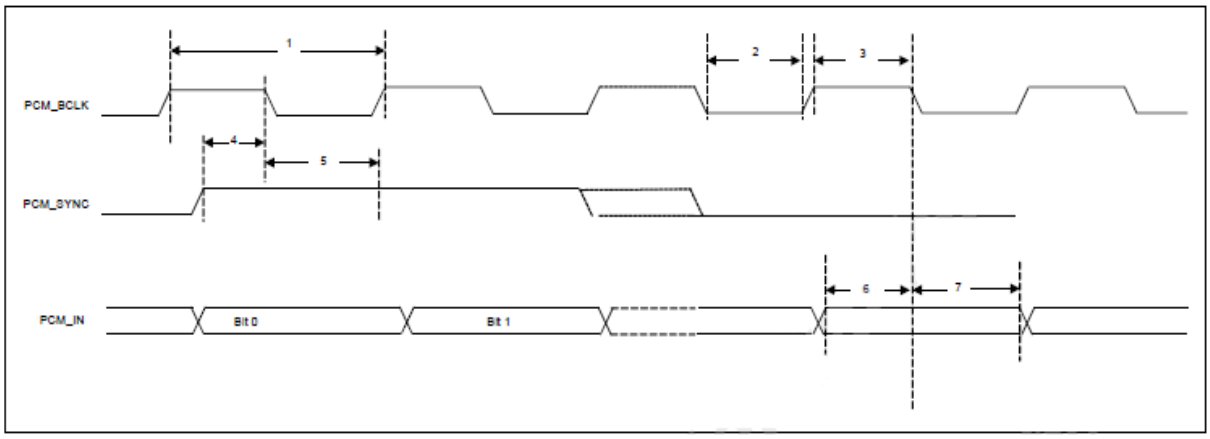


PCM Burst Mode (Receive Only, Short Frame Sync)

Reference	Characteristics	Minimum	Typical	Maximum	Unit
1	PCM bit clock frequency	–	–	24	MHz
2	PCM bit clock low	20.8	–	–	ns
3	PCM bit clock high	20.8	–	–	ns
4	PCM_SYNC setup	8	–	–	ns
5	PCM_SYNC hold	8	–	–	ns
6	PCM_IN setup	8	–	–	ns
7	PCM_IN hold	8	–	–	ns

Long Frame Sync, Burst Mode

PCM Burst Mode Timing (Receive Only, Long Frame Sync)



PCM Burst Mode (Receive Only, Long Frame Sync)

Reference	Characteristics	Minimum	Typical	Maximum	Unit
1	PCM bit clock frequency	–	–	24	MHz
2	PCM bit clock low	20.8	–	–	ns
3	PCM bit clock high	20.8	–	–	ns
4	PCM_SYNC setup	8	–	–	ns
5	PCM_SYNC hold	8	–	–	ns
6	PCM_IN setup	8	–	–	ns
7	PCM_IN hold	8	–	–	ns

8.4 UART Interface Description

The UART is a standard 4-wire interface (RX, TX, RTS, and CTS) with adjustable baud rates from 9600 bps to 4.0 Mbps. The interface features an automatic baud rate detection capability that returns a baud rate selection. Alternatively, the baud rate may be selected through a vendor-specific UART HCI command.

UART has a 1040-byte receive FIFO and a 1040-byte transmit FIFO to support EDR. Access to the FIFOs is conducted through the AHB interface through either DMA or the CPU. The UART supports the Bluetooth UART HCI specification: H4, a custom Extended H4, and H5. The default baud rate is 115.2 Kbaud.

The UART supports the 3-wire H5 UART transport, as described in the Bluetooth specification (Three-wire UART Transport Layer). Compared to H4, the H5 UART transport reduces the number of signal lines required by eliminating the CTS and RTS signals.

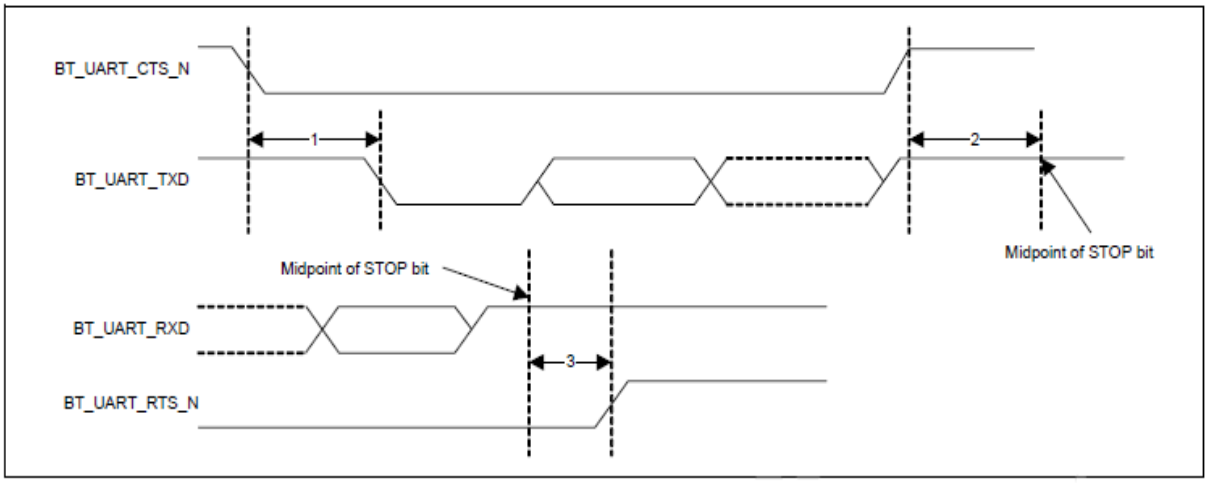
The UART can perform XON/XOFF flow control and includes hardware support for the Serial Line Input Protocol (SLIP). It can also perform wake-on activity. For example, activity on the RX or CTS inputs can wake the chip from a sleep state.

Normally, the UART baud rate is set by a configuration record downloaded after device reset, or by automatic baud rate detection, and the host does not need to adjust the baud rate. Support for changing the baud rate during normal HCI UART operation is included through a vendor-specific command that allows the host to adjust the contents of the baud rate registers. The UARTs operate correctly with the host UART as long as the combined baud rate error of the two devices is within ±2%.

Example of Common Baud Rates

Desired Rate	Actual Rate	Error (%)
4000000	4000000	0.00
3692000	3692308	0.01
3000000	3000000	0.00
2000000	2000000	0.00
1500000	1500000	0.00
1444444	1454544	0.70
921600	923077	0.16
460800	461538	0.16
230400	230796	0.17
115200	115385	0.16
57600	57692	0.16
38400	38400	0.00
28800	28846	0.16
19200	19200	0.00
14400	14423	0.16
9600	9600	0.00

UART Timing



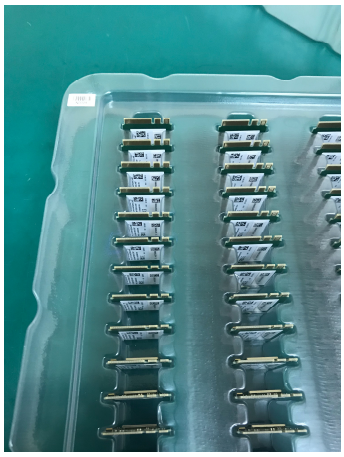
UART Timing Specifications

Ref	Characteristics	Min.	Typ.	Max.	Unit
1	Delay time, BT_UART_CTS_N low to BT_UART_TXD valid	–	–	1.5	Bit periods
2	Setup time, BT_UART_CTS_N high before midpoint of stop bit	–	–	0.5	Bit periods
3	Delay time, midpoint of stop bit to BT_UART_RTS_N high	–	–	0.5	Bit periods

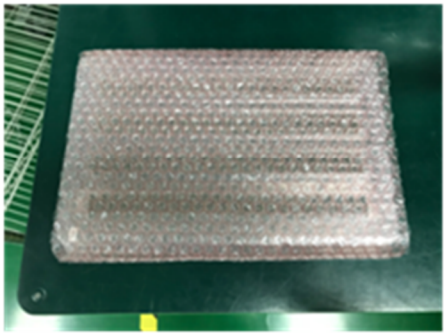
9. Package Information

9.1 Tray box

BOX : 100 PCS (100 PCS/Try)









9.2 Carton

Carton: 400 PCS (Box*4/Carton)



